Amendments to the Claims

This listing of claims will replace all prior versions and listings of claims in the application:

Listing of Claims:

Claims 1 - 17 (canceled)

Claim 18 (previously presented): A method which may be used for producing a silicon nitride film by vapor-phase growth, wherein said method comprises:

- feeding a first hydrazine gas and at least one precursor gas into a reaction chamber, wherein:
 - said precursor gas comprises at least one member selected from the group consisting of:
 - i) trisilylamine gas; and
 - ii) silylhydrazine gas; and
 - 2) at least one substrate is located in said reaction chamber; and
- forming a silicon nitride film on said substrate by reacting said first hydrazine gas and said precursor gas.

Claim 19 (previously presented): The method of claim 18, wherein:

- a) said silylhydrazine is defined by formula (I)
 - $H_3Si(R^a)N-N(R^b)R^c$ (I); and
- R^a, R^b, and R^c each comprise at least one member selected from the group consisting of:
 - 1) silyl;
 - hydrogen;
 - methyl;
 - ethyl; and
 - 5) phenyl.

Claim 20 (previously presented): The method of claim 18, further comprising:

- a) creating said precursor gas in a synthesis chamber by reacting a silylamine gas with a second hydrazine gas to form a silylhydrazine gas; and
- feeding said precursor gas into said reaction chamber from said synthesis chamber.

Claim 21 (previously presented): The method of claim 18, wherein:

a) said first hydrazine gas is defined by formula (II)

 $H(R^1)N-N(R^2)R^3$ (II); and

- b) R¹, R², and R³ each comprise at least one member selected from the group consisting of:
 - hydrogen;
 - methyl;
 - 3) ethyl; and
 - phenyl.

Claim 22 (previously presented): The method of claim 20, wherein:

a) said silylamine is defined by formula (III)

 $(H_3Si)_mN(H)_{3-m}$ (III); and

b) m is 1, 2, or 3.

Claim 23 (previously presented): The method of claim 20, wherein:

a) said second hydrazine is defined by formula (IV)

 $H(R^{x})N-N(R^{y})R^{z}$ (IV); and

- R^x, R^y, and R^z each comprise at least one member selected from the group consisting of:
 - hydrogen;
 - 2) methyl;
 - 3) ethyl; and

4) phenyl.

Claim 24 (previously presented): The method of claim 18, wherein the temperature of the reaction between said precursor gas and said first hydrazine gas is between about 300°C and about 700°C.

Claim 25 (previously presented): The method of claim 18, wherein the pressure in said reaction chamber is between about 0.1 torr and about 1000 torr.

Claim 26 (previously presented): The method of claim 18, further comprising feeding an inert dilution gas into said reaction chamber.

Claim 27 (previously presented): A method which may be used for producing silicon nitride films by vapor-phase growth, said method comprising:

- feeding a silylhydrazine gas into a reaction chamber, wherein said chamber contains at least one substrate; and
- forming a silicon nitride film on said substrate by a decomposition of said silvlhydrazine gas.

Claim 28 (previously presented): The method of claim 27, wherein:

a) said silylhydrazine is defined by formula (I)

$$H_3Si(R^a)N-N(R^b)R^c$$
 (I); and

- Ra, Rb, and Rc each comprise at least one member selected from the group consisting of:
 - silyl;
 - hydrogen;
 - methyl;
 - 4) ethyl; and
 - phenyl.

Claim 29 (previously presented): The method of claim 27, further comprising

- a) creating a silylhydrazine-containing reaction mixture in a synthesis chamber by reacting a silylamine gas with a hydrazine gas; and
- feeding said silylhydrazine-containing reaction mixture into said reaction chamber.

Claim 30 (previously presented): The method of claim 29, wherein:

a) said hydrazine is defined by formula (IV)

$$H(R^{x})N-N(R^{y})R^{z}$$
 (IV); and

- R^x, R^y, and R^z each comprise at least one member selected from the group consisting of:
 - hydrogen;
 - methyl;
 - 3) ethyl: and
 - 4) phenyl.

Claim 31 (previously presented): The method of claim 29, wherein:

a) said silylamine is defined by formula (III)

$$(H_3Si)_mN(H)_{3-m}$$
 (III); and

b) m is 1, 2, or 3.

Claim 32 (previously presented): The method of claim 27, wherein the decomposition of said silylhydrazine gas is carried out at a temperature between about 300° C and about 700°C.

Claim 33 (previously presented): The method of claim 27, wherein the pressure in said reaction chamber is between about 0.1 torr and about 1000 torr.

Claim 34 (previously presented): The method of claim 27, further comprising feeding an inert dilution gas into said reaction chamber.

Claim 35 (previously presented): A method which may be used for producing a silicon nitride film by vapor-phase growth, wherein said method comprises:

- feeding a first hydrazine gas and at least one precursor gas into a reaction chamber, wherein;
 - said precursor gas comprises at least one member selected from the group consisting of:
 - i) trisilylamine gas; and
 - ii) silylhydrazine gas;
 - 2) at least one substrate is located in said reaction chamber; and
 - the pressure in said reaction chamber is between about 0.1 torr and about 1000 torr; and
- b) feeding an inert dilution gas into said reaction chamber; and
- forming a silicon nitride film on said substrate by reacting said first hydrazine gas and said precursor gas, wherein the temperature of the reaction is between about 300°C and about 700°C.